

# Complementary Plastic Silicon Power Transistors

... designed for lower power audio amplifier and low current, high-speed switching applications.

- Low Collector-Emitter Sustaining Voltage —  
V<sub>CEO(sus)</sub> 60 Vdc (Min) — BD787, BD788
- High Current-Gain — Bandwidth Product —  
 $f_T = 50 \text{ MHz} (\text{Min}) @ I_C = 100 \text{ mA}$
- Collector-Emitter Saturation Voltage Specified at 0.5, 1.0, 2.0 and  
4.0 Adc

**NPN**  
**BD787**  
**PNP**  
**BD788**

**4 AMPERE**  
**POWER TRANSISTORS**  
**COMPLEMENTARY**  
**SILICON**  
**60 VOLTS**  
**15 WATTS**

## MAXIMUM RATINGS

Rating	Symbol	BD787 BD788	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	60	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	80	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	Vdc
Collector Current — Continuous — Peak	I <sub>C</sub>	4.0 8.0	Adc Adc
Base Current	I <sub>B</sub>	1.0	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate Above 25°C	P <sub>D</sub>	15 0.12	Watts W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	8.34	°C/W

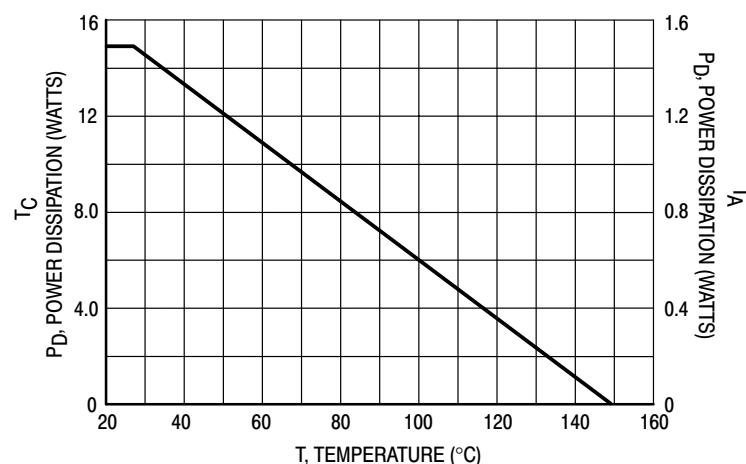
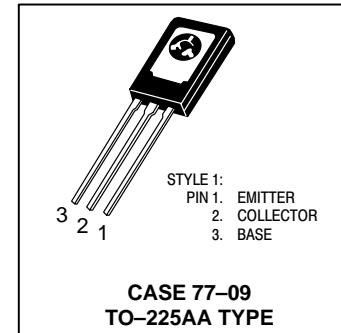


Figure 1. Power Derating

# BD787 BD788

**\*ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Sustaining Voltage (1) ( $I_C = 10 \text{ mA}, I_B = 0$ )	$V_{CEO(\text{sus})}$	60	—	Vdc
Collector Cutoff Current ( $V_{CE} = 20 \text{ Vdc}, I_B = 0$ ) ( $V_{CE} = 30 \text{ Vdc}, I_B = 0$ )	$I_{CEO}$	—	100	$\mu\text{A}$
Collector Cutoff Current ( $V_{CE} = 80 \text{ Vdc}, V_{BE(\text{off})} = 1.5 \text{ Vdc}$ ) ( $V_{CE} = 40 \text{ Vdc}, V_{BE(\text{off})} = 1.5 \text{ Vdc}, T_C = 125^\circ\text{C}$ )	$I_{CEX}$	— —	1.0 0.1	$\mu\text{A}$ $\text{mA}$
Emitter Cutoff Current ( $V_{EB} = 6.0 \text{ Vdc}, I_C = 0$ )	$I_{EBO}$	—	1.0	$\mu\text{A}$
<b>ON CHARACTERISTICS(1)</b>				
DC Current Gain ( $I_C = 200 \text{ mA}, V_{CE} = 3.0 \text{ Vdc}$ ) ( $I_C = 1.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}$ ) ( $I_C = 2.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}$ ) ( $I_C = 4.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}$ )	$h_{FE}$	40 25 20 5.0	250 — — —	—
Collector-Emitter Saturation Voltage ( $I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ ) ( $I_C = 1.0 \text{ Adc}, I_B = 100 \text{ mA}$ ) ( $I_C = 2.0 \text{ Adc}, I_B = 200 \text{ mA}$ ) ( $I_C = 4.0 \text{ Adc}, I_B = 800 \text{ mA}$ )	$V_{CE(\text{sat})}$	— — — —	0.4 0.6 0.8 2.5	Vdc
Base-Emitter Saturation Voltage ( $I_C = 2.0 \text{ Adc}, I_B = 200 \text{ mA}$ )	$V_{BE(\text{sat})}$	—	2.0	Vdc
Base-Emitter On Voltage ( $I_C = 2.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}$ )	$V_{BE(\text{on})}$	—	1.8	Vdc

## DYNAMIC CHARACTERISTICS

Current-Gain — Bandwidth Product ( $I_C = 100 \text{ mA}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ MHz}$ )	$f_T$	50	—	MHz
Output Capacitance ( $V_{CB} = 10 \text{ Vdc}, I_C = 0$ ) ( $f = 0.1 \text{ MHz}$ )	$C_{ob}$ BD787 BD788	— —	50 70	pF
Small-Signal Current Gain ( $I_C = 200 \text{ mA}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}$ )	$h_{fe}$	10	—	—

\*Indicates JEDEC Registered Data

(1) Pulse Test; Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

## BD787 BD788

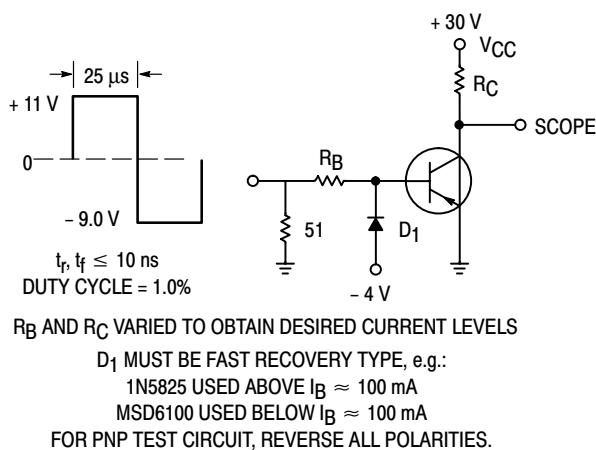


Figure 2. Switching Time Test Circuit

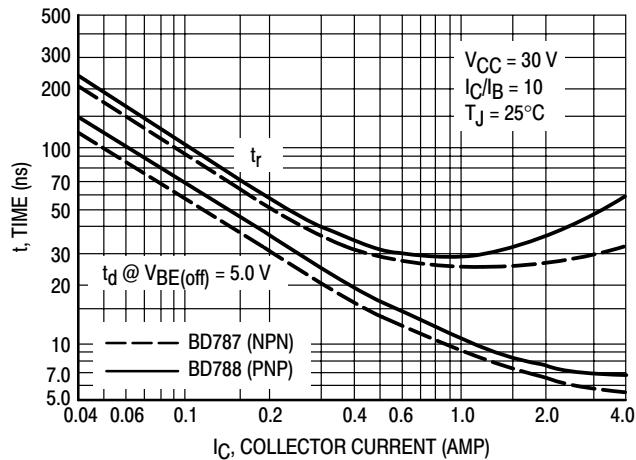


Figure 3. Turn-On Time

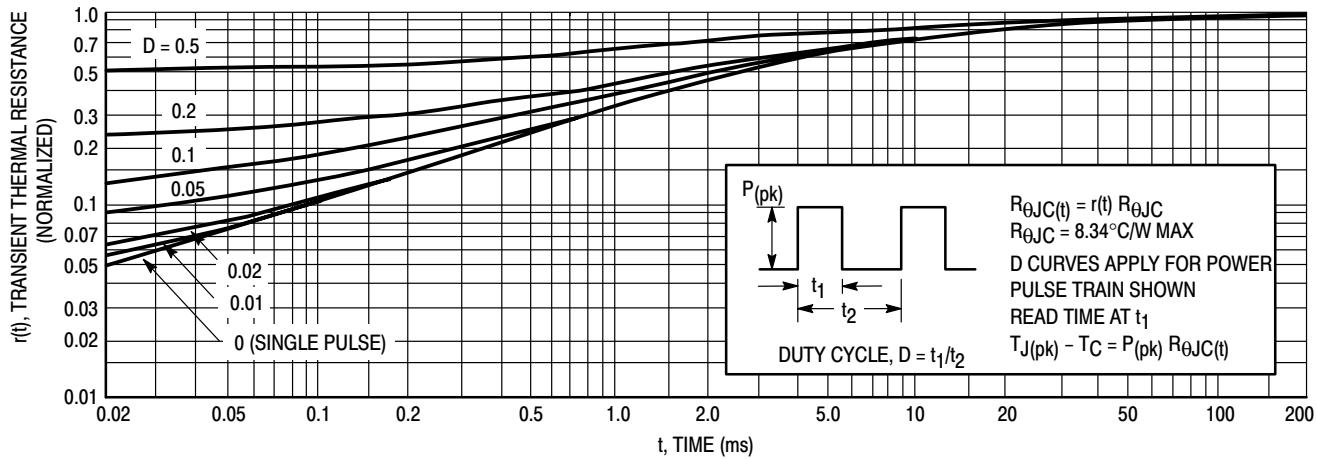


Figure 4. Thermal Response

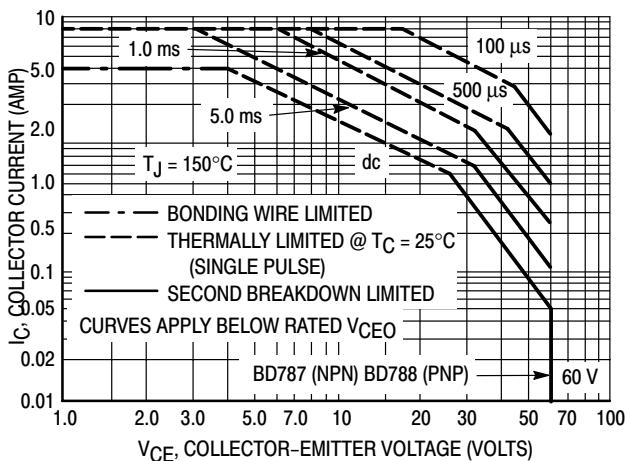
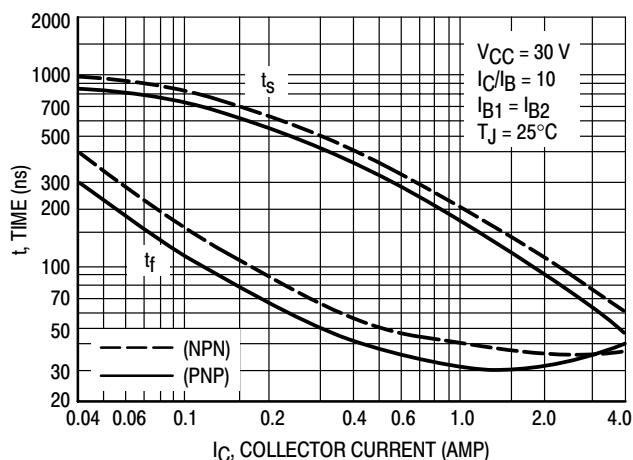


Figure 5. Active Region Safe Operating Area

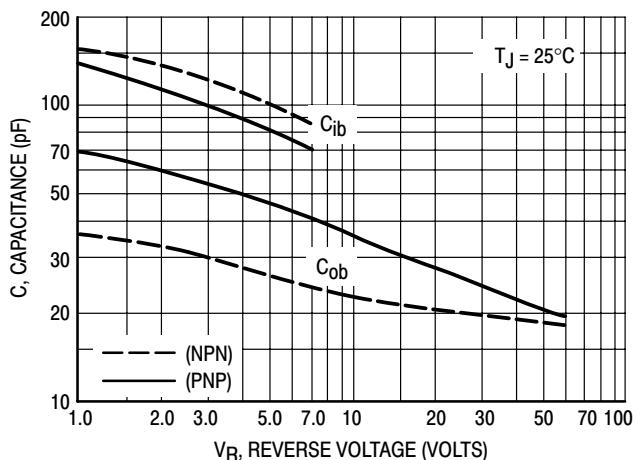
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on  $T_J(pk) = 150^\circ\text{C}$ :  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_J(pk) \leq 150^\circ\text{C}$ ,  $T_J(pk)$  may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

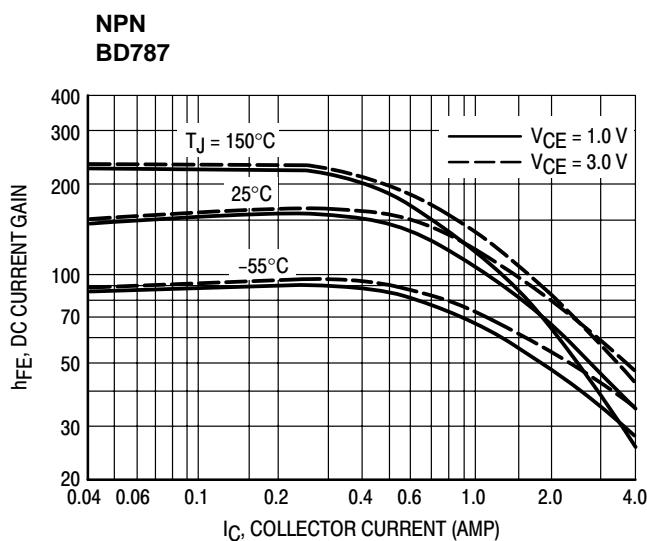
## BD787 BD788



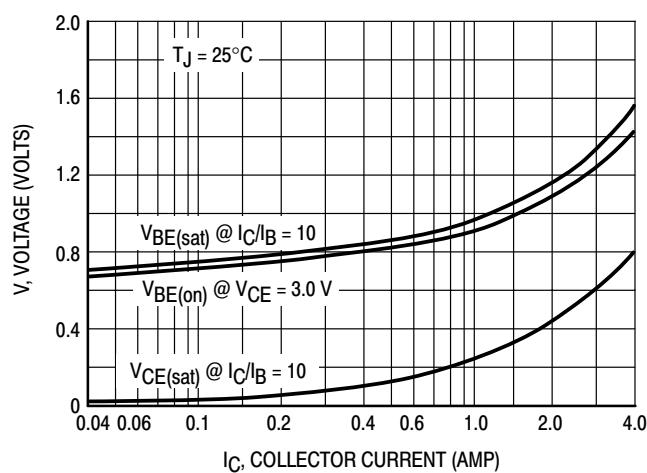
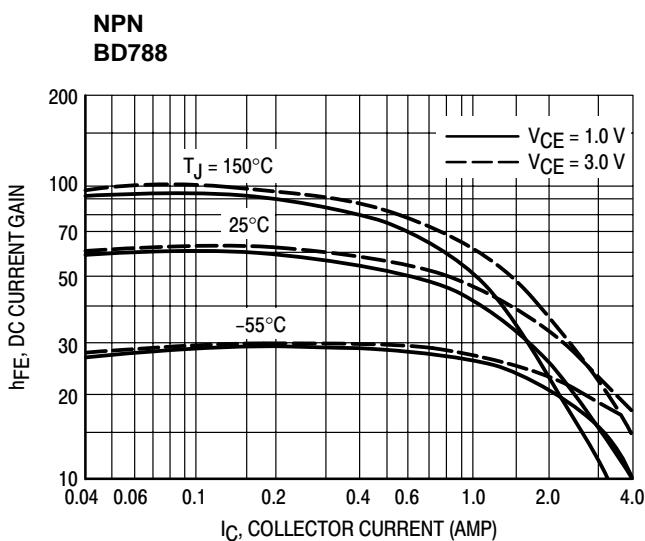
**Figure 6. Turn-Off Time**



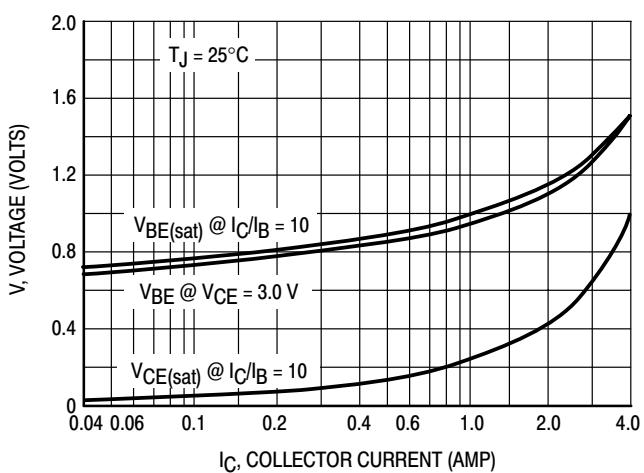
**Figure 7. Capacitance**



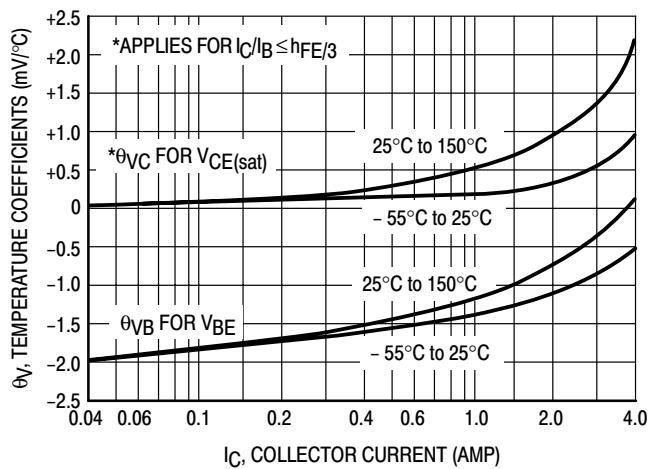
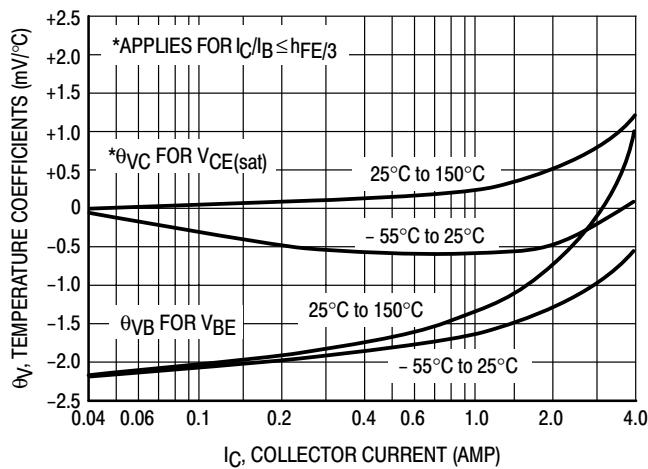
**Figure 8. DC Current Gain**



**Figure 9. "On" Voltages**



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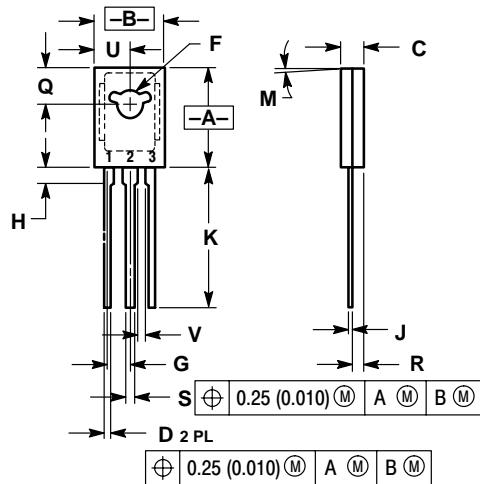


**Figure 10. Temperature Coefficients**

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## PACKAGE DIMENSIONS

### TO-225AA CASE 77-09 ISSUE W



NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.425	0.435	10.80	11.04
B	0.295	0.305	7.50	7.74
C	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094	BSC	2.39	BSC
H	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.375	0.655	14.61	16.63
M	5° TYP	5° TYP		
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
V	0.040	---	1.02	---

STYLE 1:  
PIN 1. Emitter  
2. Collector  
3. Base

## **Notes**

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